

# SL2S5002; SL2S5102

ICODE SLIX-L

Rev. 3.4 — 27 August 2012  
193134

Product data sheet  
COMPANY PUBLIC

## 1. General description

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The ICODE SLIX-L IC is a dedicated chip for smart label applications with the need for a leaner custom-specific command set, smaller memory and/or a product which takes care of the increasing demand for perfect customer privacy. This IC is another member of our ICODE SLIX product family that is fully compliant with the ISO standards ISO/IEC 15693 ([Ref. 1](#)) and ISO/IEC 18000-3 ([Ref. 4](#)), prolonging a successful story of NXP in the field of vicinity identification systems.

The ICODE system offers the possibility of operating labels simultaneously in the field of the reader antenna (anticollision). It is designed for long range applications.

### 1.1 Contactless energy and data transfer

Whenever connected to a very simple and easy-to-produce type of antenna (as a result of the 13.56 MHz carrier frequency) made out of a few windings printed, wound, etched or punched coil, the ICODE SLIX-L IC can be operated without line of sight up to a distance of 1.5 m (gate width). No battery is needed. When the smart label is positioned in the field of an interrogator antenna, the high speed RF communication interface enables data to be transmitted up to 53 kbit/s.

### 1.2 Anticollision

An intelligent anticollision function enables several tags to operate in the field simultaneously. The anticollision algorithm selects each tag individually and ensures that the execution of a transaction with a selected tag is performed correctly without data corruption resulting from other tags in the field.

### 1.3 Security and privacy aspects

- Unique Identifier (UID):  
The UID cannot be altered and guarantees the uniqueness of each label.
- Password protected Label Destroy:  
The 32-bit Destroy password enables an addressed label to be destroyed with the DESTROY SLIX-L command. That status is irreversible and the label will never respond to any command again.



- Password protected Privacy Mode:  
The 32-bit Privacy password enables a label to be set to the Privacy mode with the ENABLE PRIVACY command. In this mode the label will not respond to any command except the command GET RANDOM NUMBER, until it next receives the correct Privacy password. This mode is especially designed to meet the increasing demand to take care of the customers privacy.
- Password protected EAS and AFI functionality:  
The 32-bit EAS/AFI password enables the addressed label to be set in a mode where the EAS status and the AFI value can only be changed if the correct EAS/AFI password is transmitted to the label within the mentioned commands.

## 2. Features and benefits

### 2.1 ICODE SLIX-L RF interface (ISO/IEC 15693)

- Contactless transmission of data and supply energy (no battery needed)
- Operating distance: up to 1.5 m (depending on antenna geometry)
- Operating frequency: 13.56 MHz (ISM, world-wide licence freely available)
- Fast data transfer: up to 53 kbit/s
- High data integrity: 16-bit CRC, framing
- True anticollision
- Electronic Article Surveillance (EAS)
- Application Family Identifier (AFI) supported
- Data Storage Format Identifier (DSFID)
- ENABLE PRIVACY command with 32-bit Privacy password
- DESTROY SLIX-L command with 32-bit Destroy password
- Additional fast anticollision read
- Write distance equal to read distance

### 2.2 EEPROM

- 512 bits, organized in 16 blocks of 4 bytes each, 4 blocks are summed up to 1 page
- 50 years data retention
- Write endurance of 100000 cycles

### 2.3 Security

- Unique identifier for each device
- Lock mechanism for each user memory block (write protection)
- Lock mechanism for DSFID, AFI, EAS
- Password (32-bit) protected Label Destroy
- Password (32-bit) protected Privacy Mode
- Password (32-bit) protected EAS and AFI functionality

### 3. Applications

- Factory automation
- Industrial and laundry
- Asset management
- Libraries and rental

### 4. Ordering information

Table 1. Ordering information

| Type number | Package |   | Version |
|-------------|---------|---|---------|
|             | Name    | Description   |         |
| SL2S5002FUD | wafer   | sawn, bumped wafer, 120 μm, on film frame carrier, C <sub>i</sub> between LA and LB = 23.5 pF (typical)   | -       |
| SL2S5102FUD | wafer   | sawn, bumped wafer, 120 μm, on film frame carrier, C <sub>i</sub> between LA and LB = 97 pF (typical)   | -       |
| SL2S5002FTB | XSON3   | plastic extremely thin small outline package; no leads; 3 terminals; body 1 x 1.45 x 0.5 mm<br>C <sub>i</sub> between LA and LB = 23.5 pF (typical) | SOT1122 |

### 5. Block diagram

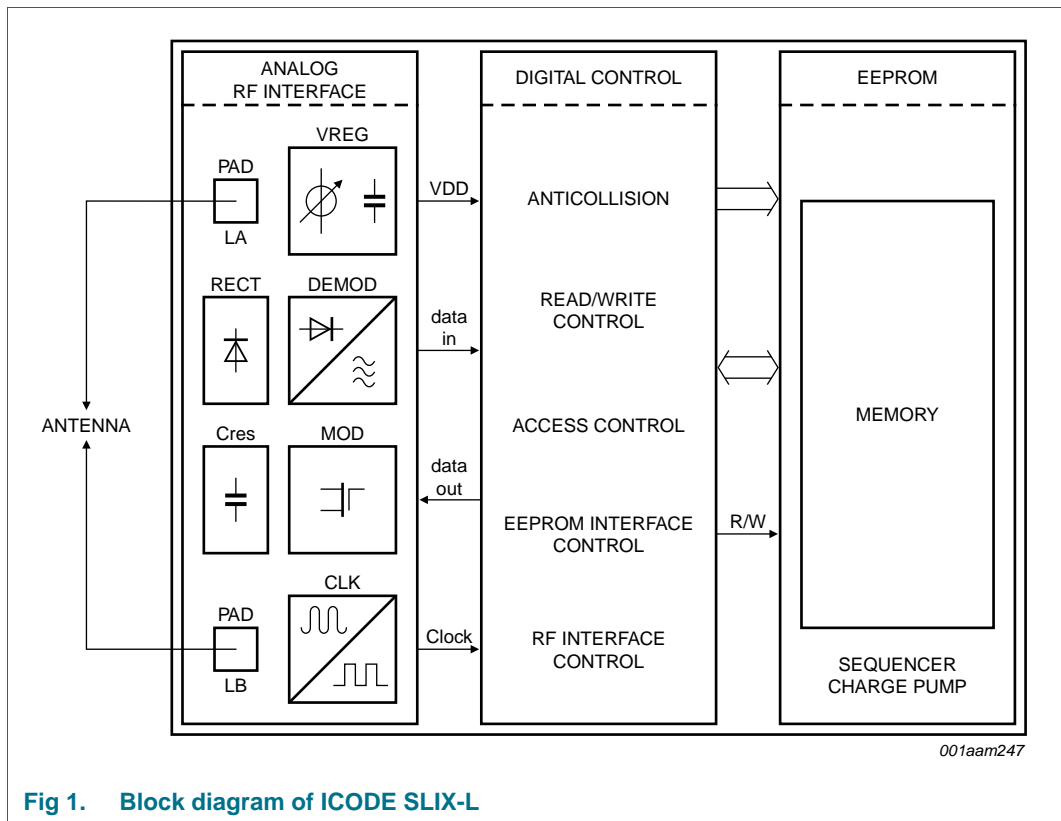
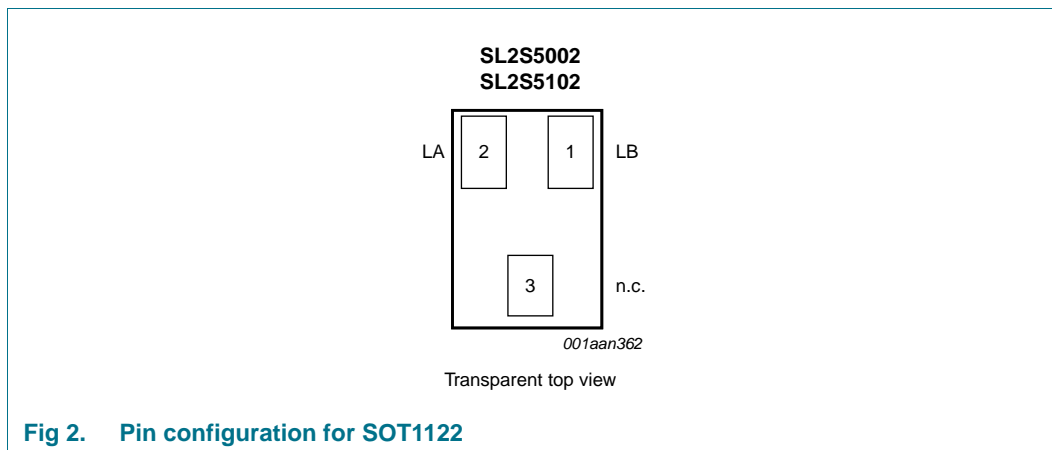


Fig 1. Block diagram of ICODE SLIX-L

## 6. Pinning information



**Table 2. Pin description SOT1122**

| Pin | Symbol | Description      |
|-----|--------|------------------|
| 1   | LB     | antenna RF input |
| 2   | LA     | antenna RF input |
| 3   | n.c.   | not connected    |

## 7. Wafer layout

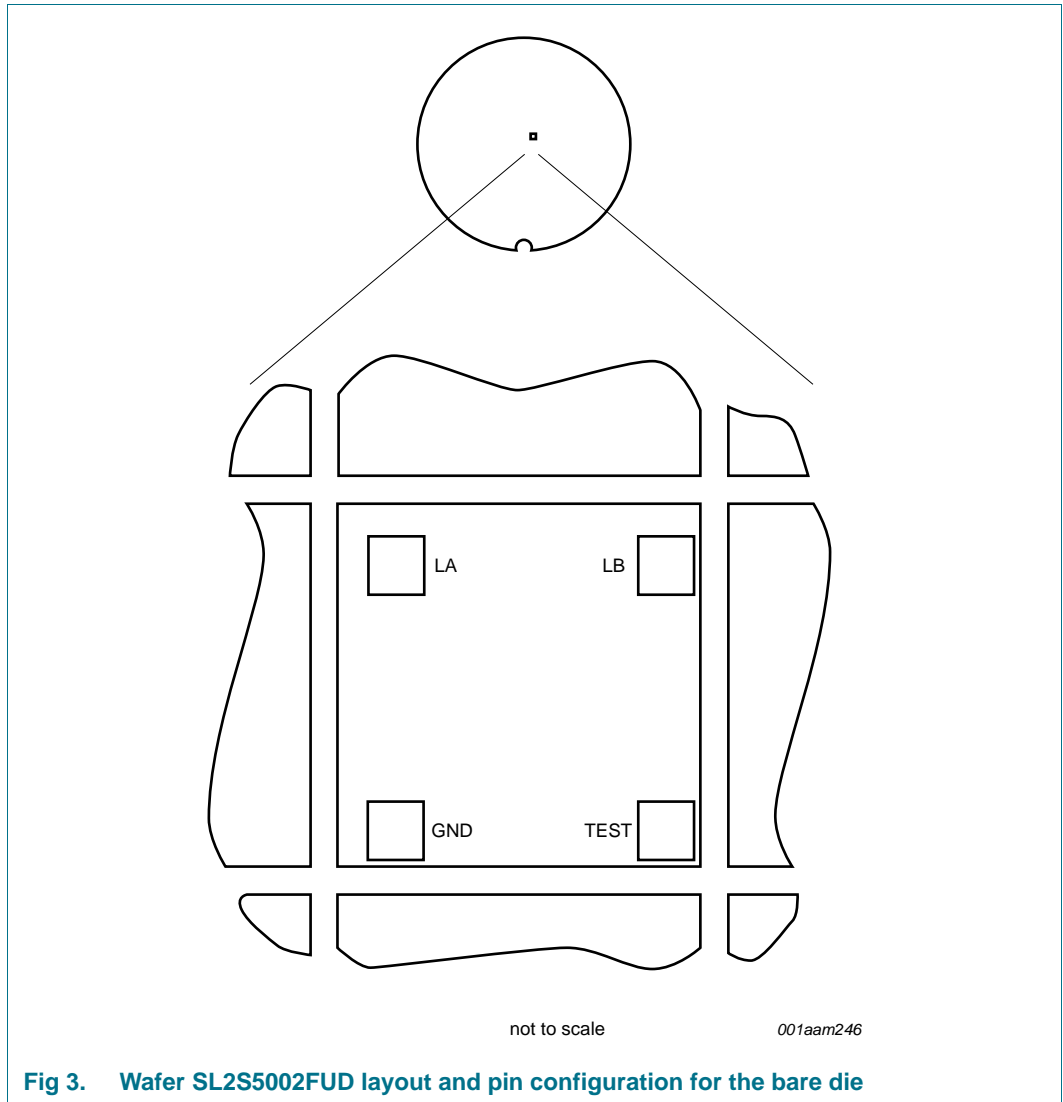
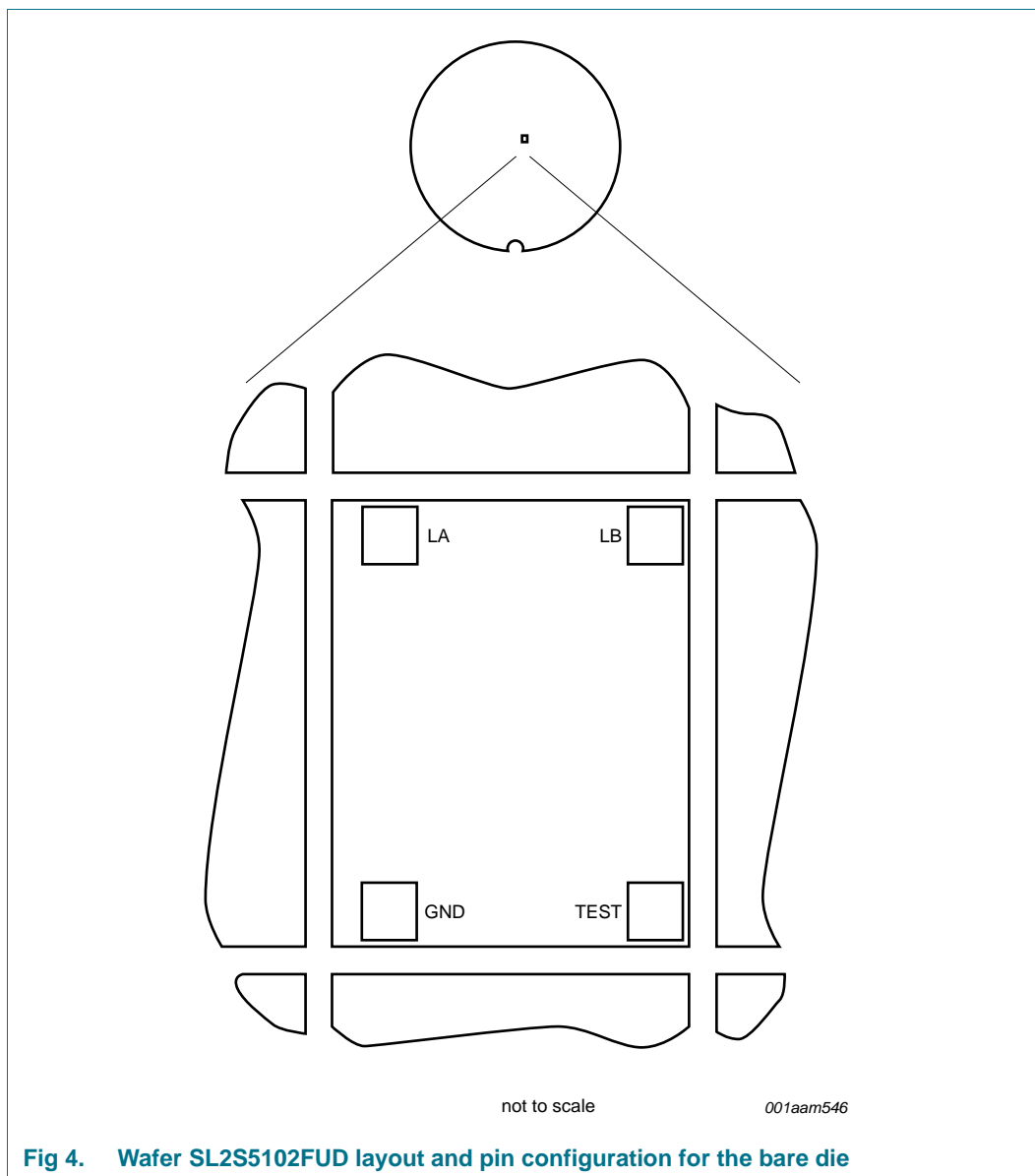


Fig 3. Wafer SL2S5002FUD layout and pin configuration for the bare die



### 7.1 Bonding pad description

**Table 3. Bonding pad description**

| Symbol | Description      |
|--------|------------------|
| LA     | antenna RF input |
| LB     | antenna RF input |
| GND    | ground           |
| TEST   | test input       |

## 8. Mechanical specification

### 8.1 Wafer specification

See [Ref. 6 "General specification for 8" wafer on UV-tape with electronic fail die marking"](#).

**Table 4. Wafer specification**

| <b>Wafer</b>                   |  |
|--------------------------------|--|
| Designation                    | each wafer is encribed with batch number and wafer number            |
| Diameter                       | 200 mm (8 inches)  |
| Thickness                      | 120 $\mu\text{m} \pm 15 \mu\text{m}$                                 |
| Process                        | CMOS 0.14 $\mu\text{m}$  |
| Batch size                     | 25 wafers  |
| Dies per wafer                 |  |
| SL2S5002FUD                    | 110050   |
| SL2S5102FUD                    | 88225  |
| <b>Wafer backside</b>          |  |
| Material                       | Si   |
| Treatment                      | ground and stress release  |
| Roughness                      | $R_a$ minimum = 0.5 $\mu\text{m}$<br>$R_t$ maximum = 5 $\mu\text{m}$ |
| <b>Chip dimensions</b>         |  |
| Die size without scribe        |  |
| SL2S5002FUD                    | 520 $\mu\text{m} \times 484 \mu\text{m} = 251680 \text{ mm}^2$       |
| SL2S5102FUD                    | 520 $\mu\text{m} \times 607 \mu\text{m} = 315640 \text{ mm}^2$       |
| Scribe line width              |  |
| X-dimension                    | 15 $\mu\text{m}$ (scribe line width measured between nitride edges)  |
| Y-dimension                    | 15 $\mu\text{m}$ (scribe line width measured between nitride edges)  |
| Number of pads                 | 4  |
| Pad location                   | non-diagonal/placed in chip corners                                  |
| Distance pad to pad LA to LB   | 400 $\mu\text{m}$  |
| Distance pad to pad LB to TEST |  |
| SL2S5002FUD                    | 360 $\mu\text{m}$  |
| SL2S5102FUD                    | 517 $\mu\text{m}$  |
| <b>Passivation on front</b>    |  |
| Type                           | sandwich structure   |
| Material                       | PE-nitride (on top)  |
| Thickness                      | 1.75 $\mu\text{m}$ total thickness of passivation                    |
| <b>Au bump</b>                 |  |
| Material                       | >99.9 % pure Au  |
| Hardness                       | 35 HV to 80 HV 0.005   |
| Shear strength                 | >70 MPa  |
| Height                         | 18 $\mu\text{m}$   |

**Table 4. Wafer specification**

|                          |  |
|--------------------------|--|
| Height uniformity        |  |
| within a die             | $\pm 2 \mu\text{m}$                    |
| within a wafer           | $\pm 3 \mu\text{m}$                    |
| wafer to wafer           | $\pm 4 \mu\text{m}$                    |
| Bump flatness            | $\pm 1.5 \mu\text{m}$                  |
| Bump size                |  |
| LA, LB                   | $60 \mu\text{m} \times 60 \mu\text{m}$ |
| TEST, GND                | $60 \mu\text{m} \times 60 \mu\text{m}$ |
| variation                | $\pm 5 \mu\text{m}$                    |
| Under bump metallization | sputtered TiW                          |

### 8.1.1 Fail die identification

No inkdots are applied to the wafer.

Electronic wafer mapping (SECS II format) covers the electrical test results and additionally the results of mechanical/visual inspection.

See [Ref. 6 "General specification for 8" wafer on UV-tape with electronic fail die marking"](#).

### 8.1.2 Map file distribution

See [Ref. 6 "General specification for 8" wafer on UV-tape with electronic fail die marking"](#).



## 9. Functional description

### 9.1 Block description

The ICODE SLIX-L IC consists of three major blocks:

- Analog RF interface
- Digital controller
- EEPROM

The analog section provides stable supply voltage and demodulates data received from the reader for processing by the digital section. The analog section's modulation transistor also transmits data back to the reader.

The digital section includes the state machines, processes the protocol and handles communication with the EEPROM.

The label requires no internal power supply. Its contactless interface generates the power supply and the system clock via the resonant circuitry by inductive coupling to the interrogator. The interface also demodulates data that are transmitted from the interrogator to the ICODE Label, and modulates the electromagnetic field for data transmission from the ICODE Label to the interrogator.

Data are stored in a non-volatile memory (EEPROM).

### 9.2 Memory organization

The 512 bit EEPROM memory is divided into 16 blocks. A block is the smallest access unit. Each block consists of 4 bytes (1 block = 32 bits). 4 blocks are summed up to 1 page. Bit 0 in each byte represents the least significant bit (LSB) and bit 7 the most significant bit (MSB), respectively.

The memory is divided into 2 parts:

- Configuration area
  - Within this part of the memory all required information is stored, such as UID, write protection, access control information, passwords, AFI and EAS. This memory area cannot be directly accessed.
- User memory
  - Within the 256 bit memory area the user data are stored. Direct read/write access to this part of the memory is possible depending on the related write protection conditions.

**Table 5. Memory organization**

| Page | Block | Byte 0 | Byte 1 | Byte 2 | Byte 3 | Description   |
|------|-------|--------|--------|--------|--------|---|
|      |       |        |        |        |        | Configuration area for internal use   |
| 0    | 0     |        |        |        |        | User memory:<br>2 pages,<br>4 blocks each,<br>4 bytes each,<br>32 bytes in total. |
|      | 1     |        |        |        |        |   |
|      | 2     |        |        |        |        |   |
|      | 3     |        |        |        |        |   |
| 1    | 4     |        |        |        |        |   |
|      | 5     |        |        |        |        |   |
|      | 6     |        |        |        |        |   |
|      | 7     |        |        |        |        |   |

Blocks 0 to 7 can be addressed with read and write commands only.

**9.2.1 Unique identifier**

The 64-bit unique identifier (UID) is programmed during the production process according to ISO/IEC 15693-3 and cannot be changed afterwards.

The 64 bits are numbered according to ISO/IEC 15693-3 starting with LSB 1 and ending with MSB 64. This is in contrast to the general used bit numbering within a byte.

The TAG type is a part of the UID (bit 41 to 48, next to the manufacturer code which is “04h” for NXP Semiconductors).

The TAG type of the ICODE SLIX-L IC is “03h”.

Bit 37 is set to logic 1 for the ICODE SLIX-L IC which indicates that this type supports the password protected AFI feature (not supported by ICODE SLI-L with bit 37 set to logic 0).

**Table 6. Unique identifier**

| MSB   |       |       |                               |       |       | LSB   |       |
|-------|-------|-------|-------------------------------|-------|-------|-------|-------|
| 64:57 | 56:49 | 48:41 | 40:1                          |       |       |       |       |
| “E0”  | “04”  | “03”  | IC manufacturer serial number |       |       |       |       |
| UID 7 | UID 6 | UID 5 | UID 4                         | UID 3 | UID 2 | UID 1 | UID 0 |

### 9.2.2 Configuration of delivered ICs

ICODE SLIX-L ICs are delivered with the following configuration by NXP Semiconductors:

- Unique identifier is unique and read only
- Write access conditions allow change to user blocks, AFI, DSFID, EAS and passwords
- All password bytes are 00h for the EAS/AFI password
- All password bytes are 0Fh for the Privacy and Destroy passwords
- Password protected Privacy Mode is disabled
- EAS and AFI password protection is disabled
- Status of EAS mode is not defined
- AFI is supported and not defined
- DSFID is supported and not defined
- User data memory is not defined

**Remark:** Because the EAS mode is undefined at delivery, the EAS mode shall be set (enabled or disabled) according to your application requirements during the test or initialization phase.

**Remark:** If password protection is not required, depending on the targeted application, it is recommended to write random passwords during the label initialization.

## 9.3 Communication principle

For detailed description of the protocol and timing please refer to ISO/IEC 15693-2 (modulation, bit-coding, framing, [Ref. 2](#)) and ISO/IEC 15693-3 (anticollision, timing, protocol, [Ref. 3](#)).

## 9.4 Supported commands

### 9.4.1 Mandatory commands

#### 9.4.1.1 INVENTORY

As defined in ISO/IEC 15693-3.

Exception: If the Privacy or Destroy mode is enabled the label will not respond.

#### 9.4.1.2 STAY QUIET

As defined in ISO/IEC 15693-3.

## 9.4.2 Optional commands

### 9.4.2.1 READ SINGLE BLOCK

As defined in ISO/IEC 15693-3.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

### 9.4.2.2 WRITE SINGLE BLOCK

As defined in ISO/IEC 15693-3.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

### 9.4.2.3 LOCK BLOCK

As defined in ISO/IEC 15693-3.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

### 9.4.2.4 SELECT

As defined in ISO/IEC 15693-3.

### 9.4.2.5 RESET TO READY

As defined in ISO/IEC 15693-3.

### 9.4.2.6 WRITE AFI

As defined in ISO/IEC 15693-3.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

**Remark:** This command maybe password protected, refer to [Section 9.4.3.13](#) “PASSWORD PROTECT EAS/AFI”.

### 9.4.2.7 LOCK AFI

As defined in ISO/IEC 15693-3.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

**Remark:** This command maybe password protected, refer to [Section 9.4.3.13](#) “PASSWORD PROTECT EAS/AFI”.

### 9.4.2.8 WRITE DSFID

As defined in ISO/IEC 15693-3.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

**9.4.2.9 LOCK DSFID**

As defined in ISO/IEC 15693-3.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

**9.4.2.10 GET SYSTEM INFORMATION**

As defined in ISO/IEC 15693-3.

The TAG type of the ICODE SLIX-L IC is “03h”.

**9.4.3 Custom commands**

The manufacturer code of NXP Semiconductors is defined in ISO/IEC 7816-6A1 ([Ref. 5](#)). It has the value “04h”.

For the structure of custom commands please refer to ISO/IEC 15693-3.

If not explicitly specified differently all address modes are supported.

**9.4.3.1 GET RANDOM NUMBER**

**Command code = B2h**

The GET RANDOM NUMBER command is required to receive a random number from the label IC. The passwords that will be transmitted with the SET PASSWORD command have to be calculated with the password and the random number (see [Section 9.4.3.2 “SET PASSWORD”](#)).

The different passwords are addressed with the password identifier.

**Table 7. Request format**

| SOF | Flags  | GET RANDOM NUMBER | IC Mfg code | UID              | CRC16   | EOF |
|-----|--------|-------------------|-------------|------------------|---------|-----|
| -   | 8 bits | 8 bits            | 8 bits      | 64 bits optional | 16 bits | -   |

**Table 8. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

**Table 9. Response format when Error\_flag NOT set**

| SOF | Flags  | Random number | CRC16   | EOF |
|-----|--------|---------------|---------|-----|
| -   | 8 bits | 16 bits       | 16 bits | -   |

### 9.4.3.2 SET PASSWORD

#### Command code = B3h

The SET PASSWORD command enables the different passwords to be transmitted to the label to access the different protected functionalities of the following commands. The SET PASSWORD command has to be executed just once for the related passwords if the label is powered.

**Remark:** The SET PASSWORD command can only be executed in Addressed or Selected mode except for the Privacy password. If the Privacy password is transmitted (see [Section 9.4.3.6 “ENABLE PRIVACY”](#)), the timing of the SET PASSWORD command is write alike.

The XOR password has to be calculated with the password and two times the received random number from the last GET RANDOM NUMBER command:

$$\text{XOR\_Password}[31:0] = \text{Password}[31:0] \text{ XOR } \{\text{Random\_Number}[15:0], \text{Random\_Number}[15:0]\}.$$

The different passwords are addressed with the password identifier.

**Table 10. Request format**

| SOF | Flags  | SET PASSWORD | IC Mfg code | UID              | Password identifier | XOR password | CRC16   | EOF |
|-----|--------|--------------|-------------|------------------|---------------------|--------------|---------|-----|
| -   | 8 bits | 8 bits       | 8 bits      | 64 bits optional | 8 bits              | 32 bits      | 16 bits | -   |

**Table 11. Password Identifier**

| Password identifier | Password       |
|---------------------|----------------|
| 04h                 | Privacy        |
| 08h                 | Destroy SLIX-L |
| 10h                 | EAS/AFI        |

**Table 12. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

**Table 13. Response format when Error\_flag NOT set**

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

**Remark:** If the IC receives an invalid password, it will not execute any following command until a Power-On Reset (POR) (RF reset) is executed.

### 9.4.3.3 WRITE PASSWORD

#### Command code = B4h

The WRITE PASSWORD command enables a new password to be written into the related memory if the related old password has already been transmitted with a SET PASSWORD command and the addressed password is not locked (see [Section 9.4.3.4 "LOCK PASSWORD"](#)).

**Remark:** The WRITE PASSWORD command can only be executed in addressed or selected mode. The new password takes effect immediately which means that the new password has to be transmitted with the SET PASSWORD command to access protected blocks/pages.

The different passwords are addressed with the password identifier.

The timing of the command is write alike.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

**Table 14. Request format**

| SOF | Flags  | WRITE PASSWORD | IC Mfg code | UID                 | Password identifier | Password | CRC16   | EOF |
|-----|--------|----------------|-------------|---------------------|---------------------|----------|---------|-----|
| -   | 8 bits | 8 bits         | 8 bits      | 64 bits<br>optional | 8 bits              | 32 bits  | 16 bits | -   |

**Table 15. Password Identifier**

| Password identifier | Password       |
|---------------------|----------------|
| 04h                 | Privacy        |
| 08h                 | Destroy SLIX-L |
| 10h                 | EAS/AFI        |

**Table 16. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

**Table 17. Response format when Error\_flag NOT set**

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

9.4.3.4 LOCK PASSWORD

Command code = B5h

The LOCK PASSWORD command enables the addressed password to be locked if the related password has already been transmitted with a SET PASSWORD command. A locked password cannot be changed.

The different passwords are addressed with the password identifier.

The timing of the command is write alike.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

Table 18. Request format

| SOF | Flags  | LOCK PASSWORD | IC Mfg code | UID              | Password identifier | CRC16   | EOF |
|-----|--------|---------------|-------------|------------------|---------------------|---------|-----|
| -   | 8 bits | 8 bits        | 8 bits      | 64 bits optional | 8 bits              | 16 bits | -   |

Table 19. Password identifier

| Password identifier | Password       |
|---------------------|----------------|
| 04h                 | Privacy        |
| 08h                 | Destroy SLIX-L |
| 10h                 | EAS/AFI        |

Table 20. Response format when Error\_flag set

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

Table 21. Response format when Error\_flag NOT set

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

9.4.3.5 DESTROY SLIX-L

Command code = B9h

The DESTROY SLIX-L command enables the ICODE SLIX-L Label IC to be destroyed if the Destroy SLIX-L password is correct. This command is irreversible and the ICODE SLIX-L will never respond to any command again.

The DESTROY SLIX-L command can only be executed in addressed or selected mode.

The XOR password has to be calculated with the password and two times the received random number from the last GET RANDOM NUMBER command:

$$\text{XOR\_Password}[31:0] = \text{Password}[31:0] \text{ XOR } \{ \text{Random\_Number}[15:0], \text{Random\_Number}[15:0] \}.$$

The timing of the command is write alike.



**Table 22. Request format**

| SOF | Flags  | DESTROY SLIX-L | IC Mfg code | UID              | XOR password | CRC16   | EOF |
|-----|--------|----------------|-------------|------------------|--------------|---------|-----|
| -   | 8 bits | 8 bits         | 8 bits      | 64 bits optional | 32 bits      | 16 bits | -   |

**Table 23. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

**Table 24. Response format when Error\_flag NOT set**

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

#### 9.4.3.6 ENABLE PRIVACY

##### Command code = BAh

The ENABLE PRIVACY command enables the ICODE SLIX-L Label IC to be set to Privacy mode if the Privacy password is correct. The ICODE SLIX-L will not respond to any command except GET RANDOM NUMBER and SET PASSWORD.

The XOR password has to be calculated with the password and two times the received random number from the last GET RANDOM NUMBER command:

$$\text{XOR\_Password}[31:0] = \text{Password}[31:0] \text{ XOR } \{ \text{Random\_Number}[15:0], \text{Random\_Number}[15:0] \}.$$

To get out of the Privacy status the valid Privacy password has to be transmitted to the IC with the SET PASSWORD command.

The timing of the command is write alike.

**Table 25. Request format**

| SOF | Flags  | ENABLE PRIVACY | IC Mfg code | UID              | XOR password | CRC16   | EOF |
|-----|--------|----------------|-------------|------------------|--------------|---------|-----|
| -   | 8 bits | 8 bits         | 8 bits      | 64 bits optional | 32 bits      | 16 bits | -   |

**Table 26. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

**Table 27. Response format when Error\_flag NOT set**

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

### 9.4.3.7 INVENTORY PAGE READ

#### Command code = B0h

When receiving the INVENTORY PAGE READ request, the ICODE SLIX-L IC performs the same as the anticollision sequence, with the difference that instead of the UID and the DSFID, the requested memory content is re-transmitted from the ICODE SLIX-L IC.

If an error is detected, the ICODE SLIX-L IC remains silent.

If the Option flag is set to logic 0, n pages of data including page protection status (password protection condition) are re-transmitted. If the Option flag is set to logic 1, n pages (4 blocks = 16 byte) of data including page protection status (password protection condition) and the part of the UID which is not part of the mask are re-transmitted.

The request contains:

- Flags
- INVENTORY PAGE READ command code
- IC manufacturer code
- AFI (if AFI flag set)
- Mask length
- Mask value (if mask length > 0)
- First page number to be read
- Number of pages to be read
- CRC 16

**Table 28. Request format**

| SOF | Flags  | INVENTORY PAGE READ | IC Mfg code | Optional AFI | Mask length | Mask value   | First page number | Number of pages | CRC16   | EOF |
|-----|--------|---------------------|-------------|--------------|-------------|--------------|-------------------|-----------------|---------|-----|
| -   | 8 bits | 8 bits              | 8 bits      | 8 bits       | 8 bits      | 0 to 64 bits | 8 bits            | 8 bits          | 16 bits | -   |

The Inventory\_flag must be set to logic 1.

The meaning of flags 5 to 8 is in accordance with table 5 in ISO/IEC 15693-3.

The number of pages in the request is one less than the number of pages that the ICODE SLIX-L IC returns in its response.

If the Option flag in the request is set to logic 0 the response contains:

**Table 29. Response format: Option flag logic 0**

| SOF                | Flags  | Data               | CRC16   | EOF |
|--------------------|--------|--------------------|---------|-----|
| -                  | 8 bits | Page status & data | 16 bits | -   |
| Repeated as needed |        |                    |         |     |

The ICODE SLIX-L IC reads the requested page(s) including page protection status and sends back their value in the response. The mechanism and timing of the INVENTORY PAGE READ command performs the same as the INVENTORY command which is described in clause 8 of ISO/IEC 15693-3.

The requested page(s) is (are) transmitted in the following format and repeated as necessary (depending on number of pages):

**Table 30. Page protection status byte**

| Page Protection Status byte   | Page data                 |
|---|---------------------------|
| 00h: page is public (not protected with Read password) or the valid Read password has been transmitted before | 16 byte page data content |
| 0Fh: page is protected with the Read password and the valid Read password has not been transmitted before     | no data                   |

If the Option flag in the request is set to logic 1, the response contains:

**Table 31. Response format: Option flag logic 1**

| SOF | Flags  | Rest of UID which is not part of the mask and slot number | Data                                     | CRC16   | EOF |
|-----|--------|---|--|---------|-----|
| -   | 8 bits | 0 to 64 bit<br>Multiple of 8 bits                         | Page status & data<br>Repeated as needed | 16 bits | -   |

The ICODE SLIX-L IC reads the requested page(s) including page protection status and sends back their value in the response. Additionally the bytes of the UID, which are not parts of the mask and the slot number in case of 16 slots, are returned. Instead of padding with zeros up to the next byte boundary, the corresponding bits of the UID are returned. The mechanism and timing of the INVENTORY PAGE READ command perform the same as the INVENTORY command which is described in clause 8 of ISO/IEC 15693-3.

The requested page(s) is (are) transmitted in the following format and repeated as necessary (depending on number of pages):

**Table 32. Page protection status byte**

| Page Protection Status Byte   | Page data                 |
|---|---------------------------|
| 00h: page is public (not protected with Read password) or the valid Read password has been transmitted before | 16 byte page data content |
| 0Fh: page is protected with the Read password and the valid Read password has not been transmitted before     | no data                   |

**Remark:** The number of bits of the re-transmitted UID can be calculated as follows:

- 16 slots: 60 bits (bit 64 to bit 5) - mask length rounded up to the next byte boundary
- 1 slot: 64 bits - mask length rounded up to the next byte boundary

**Remark:** If the sum of first page number and number of pages exceeds the total available number of user pages, the number of transmitted pages is less than the requested number of pages, which means that the last returned page is the highest available user page, followed by the 16-bit CRC and the EOF.

Example: mask length = 30 bits

Returned: bit 64 to bit 5 (30 bits) = 30 bits gives 4 bytes

**Table 33. Example: mask length = 30**

| Byte 0                                  | Byte 1 | Byte 2 | Byte 3 | Byte 4         | Byte 5 | Byte 6 | Byte 7 | UID                            |
|---|--------|--------|--------|----------------|--------|--------|--------|--------------------------------|
| mask value including padding with zeros |        |        |        | -              |        |        |        | transmitted by interrogator    |
|   |        |        |        | returned value |        |        |        | transmitted by ICODE SLIX-L IC |

#### 9.4.3.8 FAST INVENTORY PAGE READ

##### Command code = B1h

When receiving the FAST INVENTORY PAGE READ command the ICODE SLIX-L IC behaves the same as the INVENTORY PAGE READ command with the following exceptions:

The data rate in the direction ICODE SLIX-L IC to the interrogator is twice that defined in ISO/IEC 15693-3, depending on the Datarate\_flag 53 kbit (high data rate) or 13 kbit (low data rate).

The data rate from the interrogator to the ICODE SLIX-L IC and the time between the rising edge of the EOF from the interrogator to the ICODE SLIX-L IC remain unchanged (stay the same as defined in ISO/IEC 15693-3).

In the ICODE SLIX-L IC to the interrogator direction, only the single subcarrier mode is supported.

#### 9.4.3.9 SET EAS

Command code = A2h

The SET EAS command enables the EAS mode if the EAS mode is not locked. If the EAS mode is password protected the EAS password has to be first transmitted with the SET PASSWORD command.

The timing of the command is write alike.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

**Table 34. Request format**

| SOF | Flags  | SET EAS | IC Mfg code | UID                 | CRC16   | EOF |
|-----|--------|---------|-------------|---------------------|---------|-----|
| -   | 8 bits | 8 bits  | 8 bits      | 64 bits<br>optional | 16 bits | -   |

**Table 35. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

**Table 36. Response format when Error\_flag NOT set**

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

### 9.4.3.10 RESET EAS

Command code = A3h

The RESET EAS command disables the EAS mode if the EAS mode is not locked. If the EAS mode is password protected the EAS password has to be first transmitted with the SET PASSWORD command.

The timing of the command is write alike.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

**Table 37. Request format**

| SOF | Flags  | RESET EAS | IC Mfg code | UID              | CRC16   | EOF |
|-----|--------|-----------|-------------|------------------|---------|-----|
| -   | 8 bits | 8 bits    | 8 bits      | 64 bits optional | 16 bits | -   |

**Table 38. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

**Table 39. Response format when Error\_flag NOT set**

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

### 9.4.3.11 LOCK EAS

Command code = A4h

The LOCK EAS command locks the current state of the EAS mode and the EAS ID. If the EAS mode is password protected the EAS password has to be first transmitted with the SET PASSWORD command.

The timing of the command is write alike.

Option 0 (Option flag not set) is supported.

Option 1 (Option flag set) is supported.

**Table 40. Request format**

| SOF | Flags  | LOCK EAS | IC Mfg code | UID              | CRC16   | EOF |
|-----|--------|----------|-------------|------------------|---------|-----|
| -   | 8 bits | 8 bits   | 8 bits      | 64 bits optional | 16 bits | -   |

**Table 41. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

**Table 42. Response format when Error\_flag NOT set**

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

### 9.4.3.12 EAS ALARM

The EAS ALARM command can be used in the following three configurations:

- Option flag is set to 0:

EAS ID mask length and EAS ID value shall not be transmitted.

If the EAS mode is enabled, the EAS response is returned from the ICODE SLIX-L IC. This configuration is compliant with the EAS command of the ICODE SLI IC.

- Option flag is set to 1:

Within the command the EAS ID mask length has to be transmitted to identify how many bits of the following EAS ID value are valid (multiple of 8-bits). Only those ICODE SLIX-L ICs will respond with the EAS sequence which have stored the corresponding data in the EAS ID configuration (selective EAS) and if the EAS Mode is set.

If the EAS ID mask length is set to 0, the ICODE SLIX-L IC will answer with its EAS ID.

**Table 43. Request format**

| SOF | Flags  | EAS ALARM | IC Mfg code | UID              | EAS ID mask length | EAS ID value             | CRC16   | EOF |
|-----|--------|-----------|-------------|------------------|--------------------|--------------------------|---------|-----|
| -   | 8 bits | 8 bits    | 8 bits      | 64 bits optional | 8 bits optional    | 0, 8 or 16 bits optional | 16 bits | -   |

If an error is detected the ICODE SLIX-L IC remains silent.

Option flag is set to logic 0 or Option flag is set to logic 1 and the EAS ID mask length is not equal to 0:

**Table 44. Response format**

| SOF | Flags  | EAS sequence | CRC16   | EOF |
|-----|--------|--------------|---------|-----|
| -   | 8 bits | 256 bits     | 16 bits | -   |

EAS sequence (starting with the LSB, which is transmitted first; read from left to right):

```
11110100 11001101 01000110 00001110 10101011 11100101 00001001 11111110
00010111 10001101 00000001 00011100 01001011 10000001 10010010 01101110
01000001 01011011 01011001 01100001 11110110 11110101 11010001 00001101
10001111 00111001 10001011 01001000 10100101 01001110 11101100 11110111
```

Option flag is set to logic 1 and the EAS ID mask length is equal to 0:

**Table 45. Response format**

| SOF | Flags  | EAS ID value | CRC16   | EOF |
|-----|--------|--------------|---------|-----|
| -   | 8 bits | 16 bits      | 16 bits | -   |

If the EAS mode is disabled (see RESET EAS command in [Section 9.4.3.10 "RESET EAS"](#)) the ICODE SLIX-L IC remains silent.

### 9.4.3.13 PASSWORD PROTECT EAS/AFI

**Command code = A6h**

The PASSWORD PROTECT EAS/AFI command enables the password protection for EAS and/or AFI if the EAS/AFI password is first transmitted with the SET PASSWORD command.

Option flag set to logic 0: EAS will be password protected.

Option flag set to logic 1: AFI will be password protected.

Both password protections (AFI and EAS) can be enabled separately.

**Remark:** Independent of the Option flag, this write-alike command will be executed like a write command with Option flag 0 (Option flag not set).

Once the EAS/AFI password protection is enabled, it is not possible to change back to unprotected EAS and/or AFI.

The timing of the command is write alike (as write command with Option flag 0).

**Table 46. Request format**

| SOF | Flags  | PASSWORD PROTECT EAS/AFI | IC Mfg code | UID              | CRC16   | EOF |
|-----|--------|--------------------------|-------------|------------------|---------|-----|
| -   | 8 bits | 8 bits                   | 8 bits      | 64 bits optional | 16 bits | -   |

**Table 47. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

**Table 48. Response format when Error\_flag NOT set**

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

### 9.4.3.14 WRITE EAS ID

**Command code = A7h**

The command WRITE EAS ID enables a new EAS Identifier to be stored in the corresponding configuration memory. If EAS is password protected (for Set and Reset EAS) the EAS password has to be first transmitted with the SET PASSWORD command.

The timing of the command is write alike.

**Table 49. Request format**

| SOF | Flags  | WRITE EAS ID | IC Mfg code | UID              | EAS ID value | CRC16   | EOF |
|-----|--------|--------------|-------------|------------------|--------------|---------|-----|
| -   | 8 bits | 8 bits       | 8 bits      | 64 bits optional | 16 bits      | 16 bits | -   |

**Table 50. Response format when Error\_flag set**

| SOF | Flags  | Error code | CRC16   | EOF |
|-----|--------|------------|---------|-----|
| -   | 8 bits | 8 bits     | 16 bits | -   |

Table 51. Response format when Error\_flag NOT set

| SOF | Flags  | CRC16   | EOF |
|-----|--------|---------|-----|
| -   | 8 bits | 16 bits | -   |

## 9.5 Error handling

### 9.5.1 Transmission errors

According to ISO/IEC 15693 the label IC will not respond if a transmission error (CRC, bit coding, bit count, wrong framing) is detected and will silently wait for the next correct received command.

### 9.5.2 Not supported commands or options

If the received command or option is not supported, the behavior of the label IC depends on the addressing mechanism.

#### 9.5.2.1 Non Addressed Mode

The label IC remains silent.

#### 9.5.2.2 Addressed or Selected Mode

The addressed or selected label IC responds with the error code "0Fh" (error with no information given or error code is not supported).

If the Inventory flag or the Protocol Extension flag is set, the label IC will not respond if the command or option is not supported.

### 9.5.3 Parameter out of range

#### 9.5.3.1 Read commands

If the sum of the first block number and the number of blocks exceeds the total available number of user blocks, the number of transmitted blocks is less than the requested number of blocks, which means that the last returned block is the highest available user block, followed by the 16-bit CRC and the EOF.

#### 9.5.3.2 Write and lock commands

If the address of a block to be written does not exist or a block to be written is locked, the behaviour of the label IC depends on the addressing mechanism.

##### Non Addressed Mode

- The label IC remains silent and aborts the command without writing anything.

##### Addressed or Selected Mode

- The addressed or selected label IC responds with the error code "0Fh" (error with no information given or error code is not supported).

## 9.6 Data integrity

Following mechanisms are implemented in the contactless communication link between interrogator and label to ensure very reliable data transmission:



- 16-bit CRC per block
- Bit count checking
- Bit coding to distinguish between logic 1, logic 0, and no information
- Channel monitoring (protocol sequence and bit stream analysis)

## 9.7 RF interface

The definition of the RF interface is according to the standard ISO/IEC 15693-2 and ISO/IEC 15693-3.

## 10. Limiting values

**Table 52. Limiting values (Wafer)**<sup>[1][2]</sup>

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol              | Parameter                       | Conditions       | Min              | Max  | Unit |
|---------------------|---------------------------------|------------------|------------------|------|------|
| T <sub>stg</sub>    | storage temperature             |                  | -55              | +125 | °C   |
| P <sub>tot</sub>    | total power dissipation         |                  | -                | 125  | mW   |
| T <sub>j</sub>      | junction temperature            |                  | -40              | +85  | °C   |
| I <sub>i(max)</sub> | maximum input current           | LA to LB; peak   | <sup>[3]</sup> - | ±60  | mA   |
| I <sub>I</sub>      | input current                   | LA to LB; RMS    | -                | 30   | mA   |
| V <sub>ESD</sub>    | electrostatic discharge voltage | Human body model | <sup>[4]</sup> - | ±2   | kV   |

- [1] Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions other than those described in the operating conditions and electrical characteristics sections of this specification is not implied.
- [2] This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maxima.
- [3] The voltage between LA and LB is limited by the on-chip voltage limitation circuitry (corresponding to parameter I<sub>I</sub>).
- [4] For ESD measurement, the IC was mounted in a CDIP8 package.

## 11. Characteristics

### 11.1 Memory characteristics

**Table 53. EEPROM characteristics**

| Symbol               | Parameter       | Conditions                         | Min    | Typ | Max | Unit  |
|----------------------|-----------------|------------------------------------|--------|-----|-----|-------|
| $t_{\text{ret}}$     | retention time  | $T_{\text{amb}} \leq 55\text{ °C}$ | 50     | -   | -   | year  |
| $N_{\text{endu(W)}}$ | write endurance |                                    | 100000 | -   | -   | cycle |

### 11.2 Interface characteristics

**Table 54. Interface characteristics**

Typical ratings are not guaranteed. The values listed are at room temperature.

| Symbol                        | Parameter                 | Conditions                 | Min        | Typ   | Max    | Unit          |
|-------------------------------|---------------------------|----------------------------|------------|-------|--------|---------------|
| $f_i$                         | input frequency           |                            | [1] 13.553 | 13.56 | 13.567 | MHz           |
| $V_{i(\text{RMS})\text{min}}$ | minimum RMS input voltage | operating read/write       | 1.5        | -     | 1.7    | V             |
| $P_{i(\text{min})}$           | minimum input power       | operating                  | [2] -      | 40    | -      | $\mu\text{W}$ |
| $C_i$                         | input capacitance         | between LA and LB          | [3]        |       |        |               |
|                               |                           | SL2S5002FUD<br>SL2S5002FTB | 22.3       | 23.5  | 24.7   | pF            |
|                               |                           | S2SL5102FUD                | 92         | 97    | 102    | pF            |

[1] Bandwidth limitation ( $\pm 7$  kHz) according to ISM band regulations.

[2] Including losses in the resonant capacitor and rectifier.

[3] Measured with an HP4285A LCR meter at 13.56 MHz and 2 V RMS.

## 12. Marking

### 12.1 Marking SOT1122

**Table 55. Marking SOT1122**

| Type number | Marking code |
|-------------|--------------|
| SL2S5002FTB | 50           |

13. Package outline

XSON3: plastic extremely thin small outline package; no leads; 3 terminals; body 1 x 1.45 x 0.5 mm

SOT1122

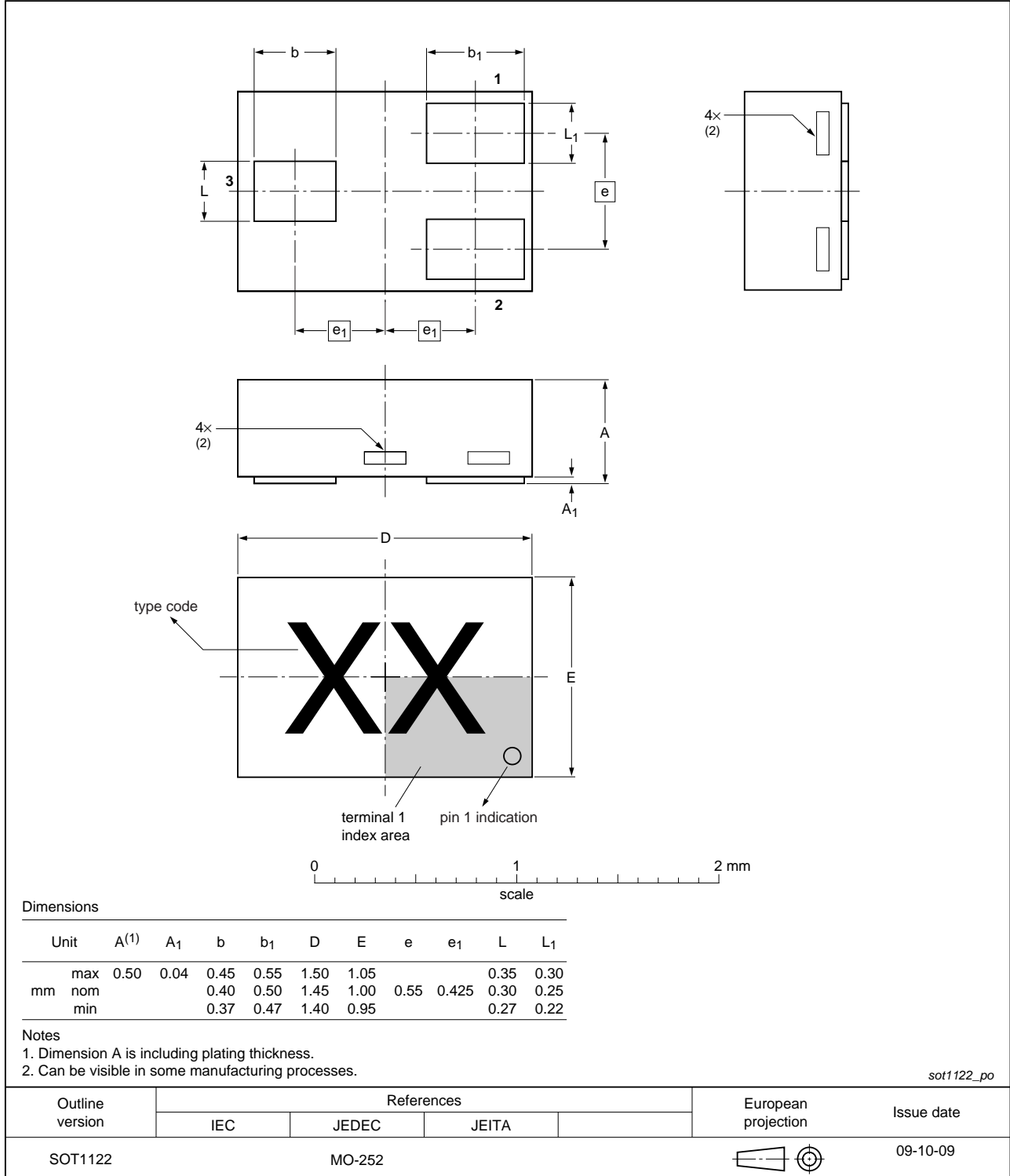
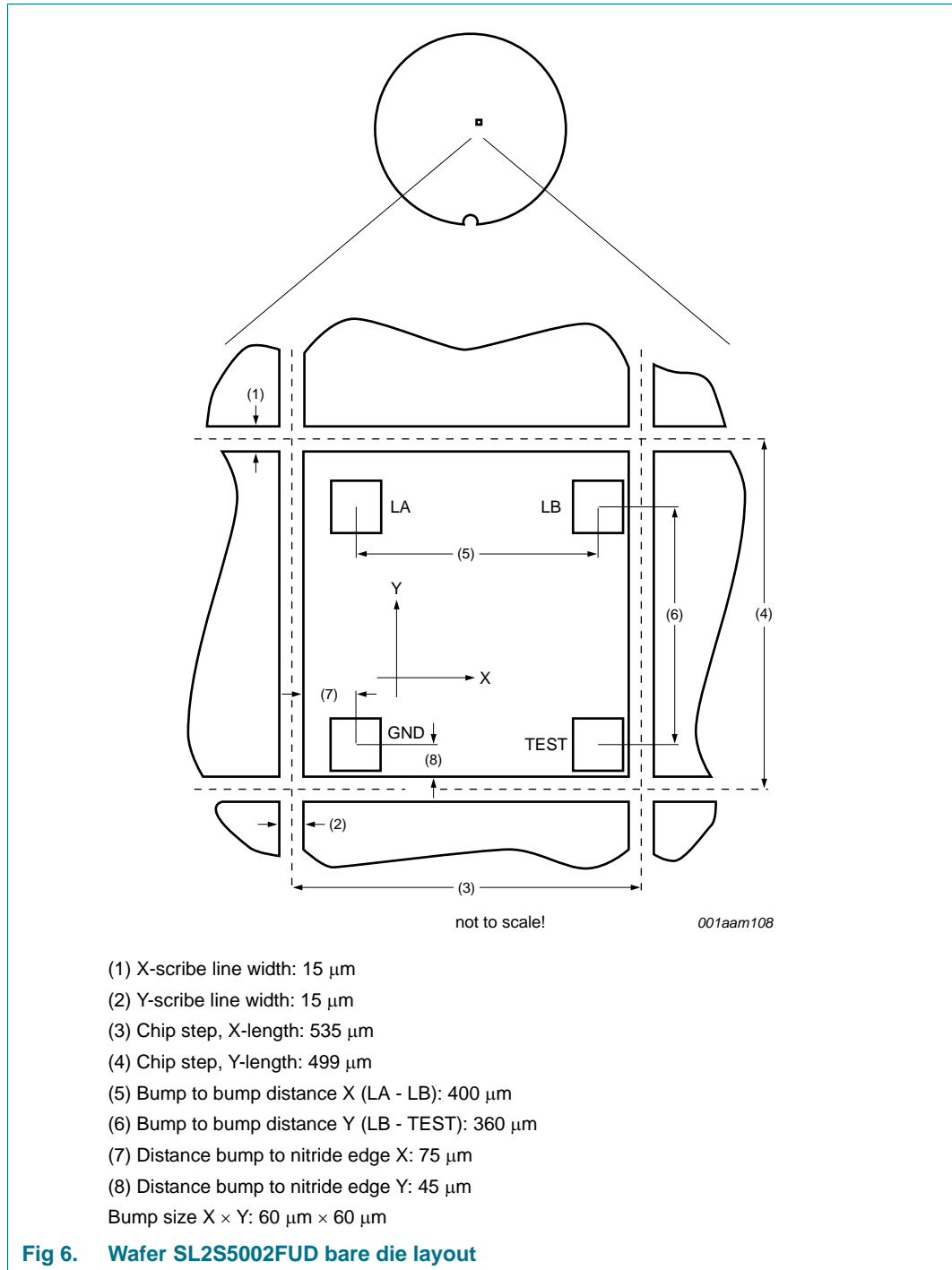
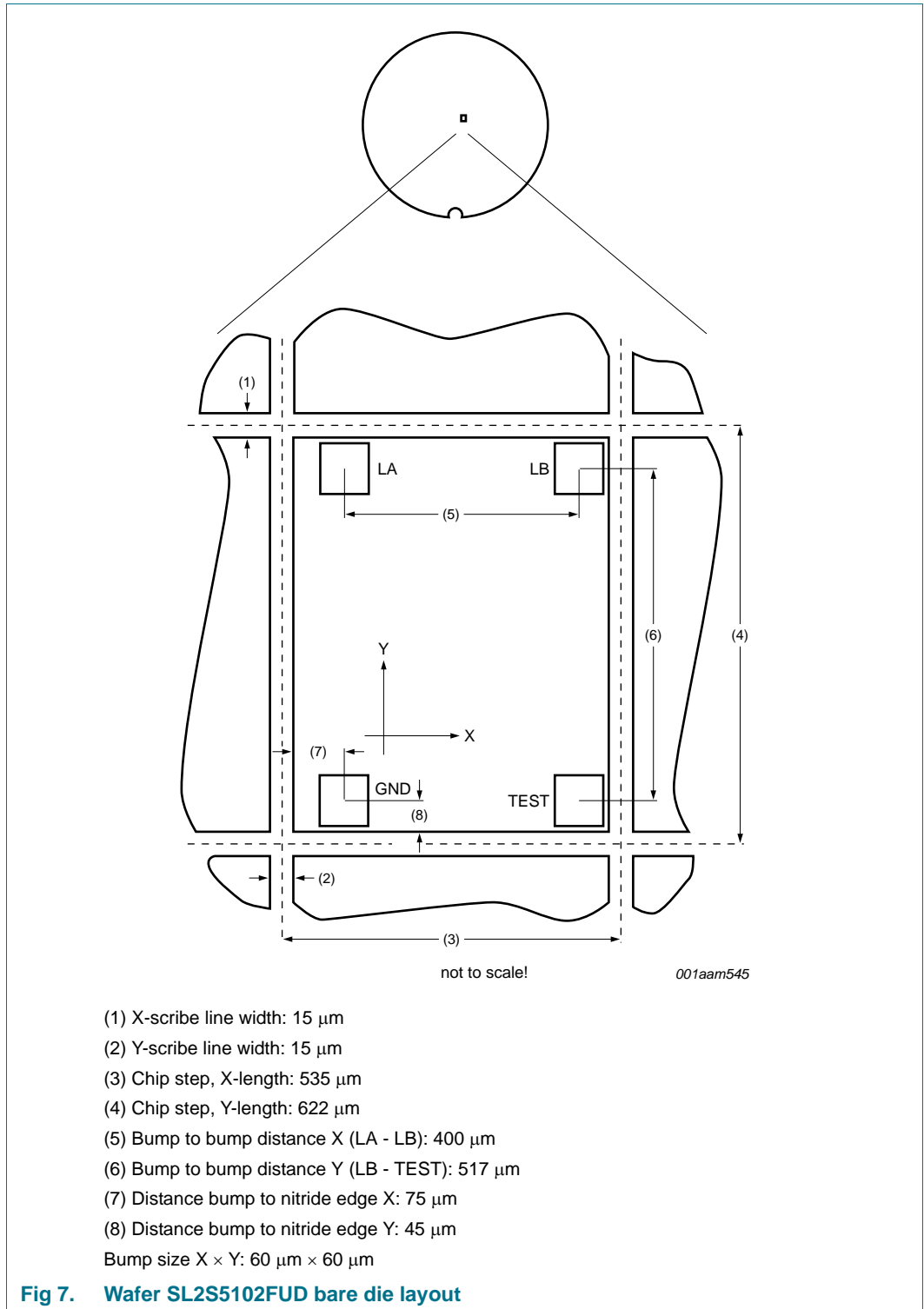


Fig 5. Package outline SOT1122

14. Bare die outline





## 15. Abbreviations

Table 56. Abbreviations

| Acronym | Description   |
|---------|---|
| AFI     | Application Family Identifier                       |
| CRC     | Cyclic Redundancy Check                             |
| DSFID   | Data Storage Format Identifier                      |
| EAS     | Electronic Article Surveillance                     |
| EEPROM  | Electrically Erasable Programmable Read Only Memory |
| EOF     | End Of Frame  |
| IC      | Integrated Circuit                                  |
| LCR     | Inductance, Capacitance, Resistance                 |
| LSB     | Least Significant Byte/Bit                          |
| MSB     | Most Significant Byte/Bit                           |
| RF      | Radio Frequency                                     |
| SOF     | Start Of Frame                                      |
| UID     | Unique Identifier                                   |

## 16. References

- [1] **ISO Standard** — ISO/IEC 15693 - Identification cards - Contactless integrated circuit cards - Vicinity cards.
- [2] **ISO Standard** — ISO/IEC 15693-2 -Identification cards - Contactless integrated circuit cards - Vicinity cards - Part 2: Air interface and initialization.
- [3] **ISO Standard** — ISO/IEC 15693-3 -Identification cards - Contactless integrated circuit cards - Vicinity cards - Part 3: Anticollision and transmission protocol.
- [4] **ISO Standard** — ISO/IEC 18000-3 - Information technology - Radio frequency identification for item management - Part 3: Parameters for air interface communications at 13.56 MHz.
- [5] **ISO Standard** — ISO/IEC 7816-6 - Identification cards - Integrated circuit cards - Part 6: Interindustry data elements for interchange.
- [6] **General specification for 8" wafer on UV-tape with electronic fail die marking** — Delivery type description – BL-ID document number: 1093\*\*1.

1. \*\* ... document version number

## 17. Revision history

Table 57. Revision history

| Document ID             | Release date   | Data sheet status      | Change notice | Supersedes              |
|-------------------------|--|------------------------|---------------|-------------------------|
| SL2S5002_SL2S5102 v.3.4 | 20120827   | Product data sheet     | -             | SL2S5002_SL2S5102 v.3.3 |
| Modifications:          | Security level changed into "COMPANY PUBLIC"   |                        |               |                         |
| SL2S5002_SL2S5102 v.3.3 | 20110119   | Product data sheet     | -             | SL2S5002_SL2S5102 v.3.2 |
| Modifications:          | <ul style="list-style-type: none"> <li>Section 12 "Marking" code for "SL2S5002FTB" corrected</li> </ul>  |                        |               |                         |
| SL2S5002_SL2S5102 v.3.2 | 20110110   | Product data sheet     | -             | SL2S5002_SL2S5102 v.3.1 |
| Modifications:          | <ul style="list-style-type: none"> <li>Type number SL2S5002FTB added</li> <li>Section 6 "Pinning information" , Section 12 "Marking" and Section 13 "Package outline" added</li> </ul> |                        |               |                         |
| SL2S5002_SL2S5102 v.3.1 | 20100930   | Product data sheet     | -             | SL2S5002 v.3.0          |
| Modifications:          | <ul style="list-style-type: none"> <li>Added type number SL2S5102</li> <li>Document layout updated</li> <li>Table 43: symbols and parameter descriptions updated</li> </ul>            |                        |               |                         |
| SL2S5002 v.3.0          | 20100527   | Product data sheet     | -             | 193120                  |
| 193120                  | 20100517   | Preliminary data sheet | -             | -                       |

## 18. Legal information

### 18.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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## 20. Tables

|   |    |   |    |
|---|----|---|----|
| Table 1. Ordering information . . . . .                     | 3  | Table 30. Page protection status byte . . . . .               | 19 |
| Table 2. Pin description SOT1122 . . . . .                  | 4  | Table 31. Response format: Option flag logic 1 . . . . .      | 19 |
| Table 3. Bonding pad description . . . . .                  | 6  | Table 32. Page protection status byte . . . . .               | 19 |
| Table 4. Wafer specification . . . . .                      | 7  | Table 33. Example: mask length = 30 . . . . .                 | 20 |
| Table 5. Memory organization . . . . .                      | 10 | Table 34. Request format . . . . .                            | 20 |
| Table 6. Unique identifier . . . . .                        | 10 | Table 35. Response format when Error_flag set . . . . .       | 20 |
| Table 7. Request format . . . . .                           | 13 | Table 36. Response format when Error_flag NOT set . . . . .   | 20 |
| Table 8. Response format when Error_flag set . . . . .      | 13 | Table 37. Request format . . . . .                            | 21 |
| Table 9. Response format when Error_flag NOT set . . . . .  | 13 | Table 38. Response format when Error_flag set . . . . .       | 21 |
| Table 10. Request format . . . . .                          | 14 | Table 39. Response format when Error_flag NOT set . . . . .   | 21 |
| Table 11. Password Identifier . . . . .                     | 14 | Table 40. Request format . . . . .                            | 21 |
| Table 12. Response format when Error_flag set . . . . .     | 14 | Table 41. Response format when Error_flag set . . . . .       | 21 |
| Table 13. Response format when Error_flag NOT set . . . . . | 14 | Table 42. Response format when Error_flag NOT set . . . . .   | 21 |
| Table 14. Request format . . . . .                          | 15 | Table 43. Request format . . . . .                            | 22 |
| Table 15. Password Identifier . . . . .                     | 15 | Table 44. Response format . . . . .                           | 22 |
| Table 16. Response format when Error_flag set . . . . .     | 15 | Table 45. Response format . . . . .                           | 22 |
| Table 17. Response format when Error_flag NOT set . . . . . | 15 | Table 46. Request format . . . . .                            | 23 |
| Table 18. Request format . . . . .                          | 16 | Table 47. Response format when Error_flag set . . . . .       | 23 |
| Table 19. Password identifier . . . . .                     | 16 | Table 48. Response format when Error_flag NOT set . . . . .   | 23 |
| Table 20. Response format when Error_flag set . . . . .     | 16 | Table 49. Request format . . . . .                            | 23 |
| Table 21. Response format when Error_flag NOT set . . . . . | 16 | Table 50. Response format when Error_flag set . . . . .       | 23 |
| Table 22. Request format . . . . .                          | 17 | Table 51. Response format when Error_flag NOT set . . . . .   | 24 |
| Table 23. Response format when Error_flag set . . . . .     | 17 | Table 52. Limiting values (Wafer) <sup>[1][2]</sup> . . . . . | 25 |
| Table 24. Response format when Error_flag NOT set . . . . . | 17 | Table 53. EEPROM characteristics . . . . .                    | 26 |
| Table 25. Request format . . . . .                          | 17 | Table 54. Interface characteristics . . . . .                 | 26 |
| Table 26. Response format when Error_flag set . . . . .     | 17 | Table 55. Marking SOT1122 . . . . .                           | 26 |
| Table 27. Response format when Error_flag NOT set . . . . . | 17 | Table 56. Abbreviations . . . . .                             | 30 |
| Table 28. Request format . . . . .                          | 18 | Table 57. Revision history . . . . .                          | 31 |
| Table 29. Response format: Option flag logic 0 . . . . .    | 18 |   |    |

## 21. Figures

|  |    |
|--|----|
| Fig 1. Block diagram of ICODE SLIX-L . . . . .                                   | 3  |
| Fig 2. Pin configuration for SOT1122 . . . . .                                   | 4  |
| Fig 3. Wafer SL2S5002FUD layout and pin configuration for the bare die . . . . . | 5  |
| Fig 4. Wafer SL2S5102FUD layout and pin configuration for the bare die . . . . . | 6  |
| Fig 5. Package outline SOT1122 . . . . .   | 27 |
| Fig 6. Wafer SL2S5002FUD bare die layout . . . . .                               | 28 |
| Fig 7. Wafer SL2S5102FUD bare die layout . . . . .                               | 29 |

## 22. Contents

|          |   |          |           |                                   |           |
|----------|---|----------|-----------|-----------------------------------|-----------|
| <b>1</b> | <b>General description</b> . . . . .      | <b>1</b> | 9.4.3.7   | INVENTORY PAGE READ               | 18        |
| 1.1      | Contactless energy and data transfer      | 1        | 9.4.3.8   | FAST INVENTORY PAGE READ          | 20        |
| 1.2      | Anticollision                             | 1        | 9.4.3.9   | SET EAS                           | 20        |
| 1.3      | Security and privacy aspects              | 1        | 9.4.3.10  | RESET EAS                         | 21        |
| <b>2</b> | <b>Features and benefits</b> . . . . .    | <b>2</b> | 9.4.3.11  | LOCK EAS                          | 21        |
| 2.1      | ICODE SLIX-L RF interface (ISO/IEC 15693) | 2        | 9.4.3.12  | EAS ALARM                         | 22        |
| 2.2      | EEPROM                                    | 2        | 9.4.3.13  | PASSWORD PROTECT EAS/AFI          | 23        |
| 2.3      | Security                                  | 2        | 9.4.3.14  | WRITE EAS ID                      | 23        |
| <b>3</b> | <b>Applications</b> . . . . .             | <b>3</b> | 9.5       | Error handling                    | 24        |
| <b>4</b> | <b>Ordering information</b> . . . . .     | <b>3</b> | 9.5.1     | Transmission errors               | 24        |
| <b>5</b> | <b>Block diagram</b> . . . . .            | <b>3</b> | 9.5.2     | Not supported commands or options | 24        |
| <b>6</b> | <b>Pinning information</b> . . . . .      | <b>4</b> | 9.5.2.1   | Non Addressed Mode                | 24        |
| <b>7</b> | <b>Wafer layout</b> . . . . .             | <b>5</b> | 9.5.2.2   | Addressed or Selected Mode        | 24        |
| 7.1      | Bonding pad description                   | 6        | 9.5.3     | Parameter out of range            | 24        |
| <b>8</b> | <b>Mechanical specification</b> . . . . . | <b>7</b> | 9.5.3.1   | Read commands                     | 24        |
| 8.1      | Wafer specification                       | 7        | 9.5.3.2   | Write and lock commands           | 24        |
| 8.1.1    | Fail die identification                   | 8        |           | Non Addressed Mode                | 24        |
| 8.1.2    | Map file distribution                     | 8        | 9.6       | Addressed or Selected Mode        | 24        |
| <b>9</b> | <b>Functional description</b> . . . . .   | <b>9</b> | 9.7       | Data integrity                    | 24        |
| 9.1      | Block description                         | 9        | <b>10</b> | RF interface                      | 25        |
| 9.2      | Memory organization                       | 9        | <b>11</b> | <b>Limiting values</b>            | <b>25</b> |
| 9.2.1    | Unique identifier                         | 10       | <b>11</b> | <b>Characteristics</b>            | <b>26</b> |
| 9.2.2    | Configuration of delivered ICs            | 11       | 11.1      | Memory characteristics            | 26        |
| 9.3      | Communication principle                   | 11       | 11.2      | Interface characteristics         | 26        |
| 9.4      | Supported commands                        | 11       | <b>12</b> | <b>Marking</b>                    | <b>26</b> |
| 9.4.1    | Mandatory commands                        | 11       | 12.1      | Marking SOT1122                   | 26        |
| 9.4.1.1  | INVENTORY                                 | 11       | <b>13</b> | <b>Package outline</b>            | <b>27</b> |
| 9.4.1.2  | STAY QUIET                                | 11       | <b>14</b> | <b>Bare die outline</b>           | <b>28</b> |
| 9.4.2    | Optional commands                         | 12       | <b>15</b> | <b>Abbreviations</b>              | <b>30</b> |
| 9.4.2.1  | READ SINGLE BLOCK                         | 12       | <b>16</b> | <b>References</b>                 | <b>30</b> |
| 9.4.2.2  | WRITE SINGLE BLOCK                        | 12       | <b>17</b> | <b>Revision history</b>           | <b>31</b> |
| 9.4.2.3  | LOCK BLOCK                                | 12       | <b>18</b> | <b>Legal information</b>          | <b>32</b> |
| 9.4.2.4  | SELECT                                    | 12       | 18.1      | Data sheet status                 | 32        |
| 9.4.2.5  | RESET TO READY                            | 12       | 18.2      | Definitions                       | 32        |
| 9.4.2.6  | WRITE AFI                                 | 12       | 18.3      | Disclaimers                       | 32        |
| 9.4.2.7  | LOCK AFI                                  | 12       | 18.4      | Trademarks                        | 33        |
| 9.4.2.8  | WRITE DSFID                               | 12       | <b>19</b> | <b>Contact information</b>        | <b>33</b> |
| 9.4.2.9  | LOCK DSFID                                | 13       | <b>20</b> | <b>Tables</b>                     | <b>34</b> |
| 9.4.2.10 | GET SYSTEM INFORMATION                    | 13       | <b>21</b> | <b>Figures</b>                    | <b>34</b> |
| 9.4.3    | Custom commands                           | 13       | <b>22</b> | <b>Contents</b>                   | <b>35</b> |
| 9.4.3.1  | GET RANDOM NUMBER                         | 13       |           |                                   |           |
| 9.4.3.2  | SET PASSWORD                              | 14       |           |                                   |           |
| 9.4.3.3  | WRITE PASSWORD                            | 15       |           |                                   |           |
| 9.4.3.4  | LOCK PASSWORD                             | 16       |           |                                   |           |
| 9.4.3.5  | DESTROY SLIX-L                            | 16       |           |                                   |           |
| 9.4.3.6  | ENABLE PRIVACY                            | 17       |           |                                   |           |

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Date of release: 27 August 2012  
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**Телефон:** +7 812 627 14 35

**Электронная почта:** [sales@st-electron.ru](mailto:sales@st-electron.ru)

**Адрес:** 198099, Санкт-Петербург,  
Промышленная ул, дом № 19, литера Н,  
помещение 100-Н Офис 331